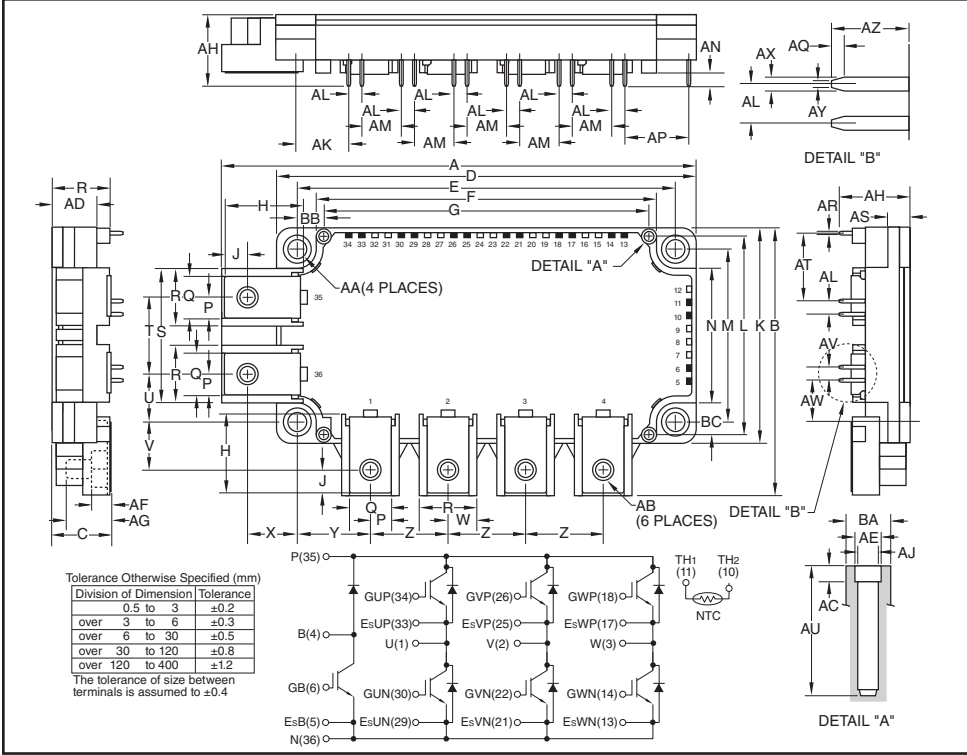


## CM150RX-24S

### Six IGBT + Brake NX-Series Module 150 Amperes/1200 Volts



**Description:**  
 Powerex IGBT Modules are designed for use in switching applications. Each module consists of six IGBT Transistors in a three phase bridge configuration and a seventh IGBT with free-wheel diode for dynamic braking. All components and interconnects are isolated from the heat sinking baseplate, offering simplified system assembly and thermal management.

- Features:**
- Low Drive Power
  - Low  $V_{CE(sat)}$
  - Discrete Super-Fast Recovery Free-Wheel Diode
  - Isolated Baseplate for Easy Heat Sinking

- Applications:**
- AC Motor Control
  - Motion/Servo Control
  - Photovoltaic/Fuel Cell

**Ordering Information:**  
 Example: Select the complete module number you desire from the table below -i.e. CM150RX-24S is a 1200V ( $V_{CES}$ ), 150 Ampere Six-IGBT + Brake Power Module.

**Outline Drawing and Circuit Diagram**

| Dimensions | Inches          | Millimeters   |
|------------|-----------------|---------------|
| A          | 5.39            | 136.9         |
| B          | 3.03            | 77.1          |
| C          | 0.67+0.04/-0.02 | 17.0+1.0/-0.5 |
| D          | 4.79            | 121.7         |
| E          | 4.33±0.02       | 110.0±0.5     |
| F          | 3.89            | 99.0          |
| G          | 3.72            | 94.5          |
| H          | 0.83            | 21.14         |
| J          | 0.37            | 6.5           |
| K          | 2.44            | 62.0          |
| L          | 2.26            | 57.5          |
| M          | 1.97±0.02       | 50.0±0.5      |
| N          | 1.53            | 39.0          |
| P          | 0.24            | 6.0           |
| Q          | 0.48            | 12.0          |
| R          | 0.67            | 17.0          |
| S          | 1.53            | 39.0          |
| T          | 0.87            | 22.0          |
| U          | 0.55            | 14.0          |
| V          | 0.54            | 13.64         |
| W          | 0.33            | 8.5           |
| X          | 0.53            | 13.5          |
| Y          | 0.81            | 20.71         |
| Z          | 0.9             | 22.86         |
| AA         | 0.22 Dia.       | 5.5 Dia.      |
| AB         | M5              | M5            |

| Dimensions | Inches     | Millimeters |
|------------|------------|-------------|
| AC         | 0.12       | 3.0         |
| AD         | 0.51       | 13.0        |
| AE         | 0.102 Dia. | 2.6 Dia.    |
| AF         | 0.21       | 5.4         |
| AG         | 0.49       | 12.5        |
| AH         | 0.81       | 20.5        |
| AJ         | 0.088 Dia. | 2.25 Dia.   |
| AK         | 0.59       | 15.00       |
| AL         | 0.15       | 3.81        |
| AM         | 0.45       | 11.43       |
| AN         | 0.14       | 3.5         |
| AP         | 0.75       | 19.05       |
| AQ         | 0.05       | 1.2         |
| AR         | 0.03       | 0.8         |
| AS         | 0.27       | 7.0         |
| AT         | 0.77       | 19.68       |
| AU         | 0.49       | 12.5        |
| AV         | 0.60       | 15.24       |
| AW         | 0.46       | 11.66       |
| AX         | 0.04       | 1.15        |
| AY         | 0.02       | 0.65        |
| AZ         | 0.29       | 7.4         |
| BA         | 0.17 Dia.  | 4.3 Dia.    |
| BB         | 0.30       | 7.75        |
| BC         | 0.14       | 3.75        |

| Type | Current Rating<br>Amperes | $V_{CES}$<br>Volts (x 50) |
|------|---------------------------|---------------------------|
| CM   | 150                       | 24                        |

**CM150RX-24S**  
**Six IGBT + Brake NX-Series Module**  
 150 Amperes/1200 Volts

**Absolute Maximum Ratings,  $T_j = 25^\circ\text{C}$  unless otherwise specified**

**Inverter Part IGBT/FWDi**

| Characteristics   | Symbol         | Rating   | Units   |
|---|----------------|----------|---------|
| Collector-Emitter Voltage ( $V_{GE} = 0V$ )               | $V_{CES}$      | 1200     | Volts   |
| Gate-Emitter Voltage ( $V_{CE} = 0V$ )                    | $V_{GES}$      | $\pm 20$ | Volts   |
| Collector Current (DC, $T_C = 120^\circ\text{C}$ )*2,*4   | $I_C$          | 150      | Amperes |
| Collector Current (Pulse, Repetitive)*3                   | $I_{CRM}$      | 300      | Amperes |
| Total Power Dissipation ( $T_C = 25^\circ\text{C}$ )*2,*4 | $P_{tot}$      | 1150     | Watts   |
| Emitter Current*2   | $I_E^{*1}$     | 150      | Amperes |
| Emitter Current (Pulse, Repetitive)*3                     | $I_{ERM}^{*1}$ | 300      | Amperes |

**Brake Part IGBT/ClampDi**

| Characteristics   | Symbol         | Rating   | Units   |
|---|----------------|----------|---------|
| Collector-Emitter Voltage ( $V_{GE} = 0V$ )               | $V_{CES}$      | 1200     | Volts   |
| Gate-Emitter Voltage ( $V_{CE} = 0V$ )                    | $V_{GES}$      | $\pm 20$ | Volts   |
| Collector Current (DC, $T_C = 122^\circ\text{C}$ )*2,*4   | $I_C$          | 75       | Amperes |
| Collector Current (Pulse, Repetitive)*3                   | $I_{CRM}$      | 150      | Amperes |
| Total Power Dissipation ( $T_C = 25^\circ\text{C}$ )*2,*4 | $P_{tot}$      | 600      | Watts   |
| Repetitive Peak Reverse Voltage ( $V_{GE} = 0V$ )         | $V_{RRM}$      | 1200     | Volts   |
| Forward Current*2   | $I_E^{*1}$     | 75       | Amperes |
| Forward Current (Pulse, Repetitive)*3                     | $I_{ERM}^{*1}$ | 150      | Amperes |

**Module**

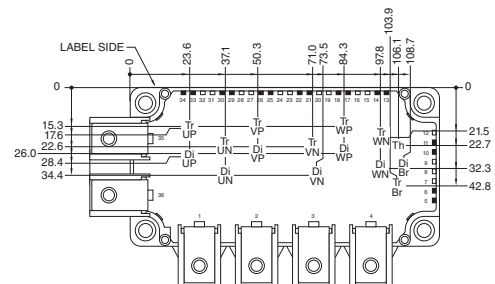
| Characteristics  | Symbol       | Rating      | Units            |
|--|--------------|-------------|------------------|
| Isolation Voltage (Terminals to Baseplate, RMS, $f = 60\text{Hz}$ , AC 1 minute) | $V_{ISO}$    | 2500        | Volts            |
| Maximum Junction Temperature, Instantaneous Event (Overload)                     | $T_{j(max)}$ | 175         | $^\circ\text{C}$ |
| Maximum Case Temperature*4   | $T_C(max)$   | 125         | $^\circ\text{C}$ |
| Operating Junction Temperature, Continuous Operation (Under Switching)           | $T_{j(op)}$  | -40 to +150 | $^\circ\text{C}$ |
| Storage Temperature  | $T_{stg}$    | -40 to +125 | $^\circ\text{C}$ |

\*1 Represent ratings and characteristics of the anti-parallel, emitter-to-collector free wheeling diode (FWDi).

\*2 Junction temperature ( $T_j$ ) should not increase beyond maximum junction temperature ( $T_{j(max)}$ ) rating.

\*3 Pulse width and repetition rate should be such that device junction temperature ( $T_j$ ) does not exceed  $T_{j(max)}$  rating.

\*4 Case temperature ( $T_C$ ) and heatsink temperature ( $T_s$ ) is measured on the surface (mounting side) of the baseplate and the heatsink side just under the chips. Refer to the figure to the right for chip location. The heatsink thermal resistance should be measured just under the chips.



Each mark points to the center position of each chip.

Tr\*P / Tr\*N / TrBr (\* = U/V/W): IGBT      Di\*P / Di\*N (\* = U/V/W): FWDi  
 DIBr: Clamp      Tr: NTC Thermistor

**CM150RX-24S**  
**Six IGBT + Brake NX-Series Module**  
 150 Amperes/1200 Volts

**Electrical Characteristics,  $T_j = 25^\circ\text{C}$  unless otherwise specified**

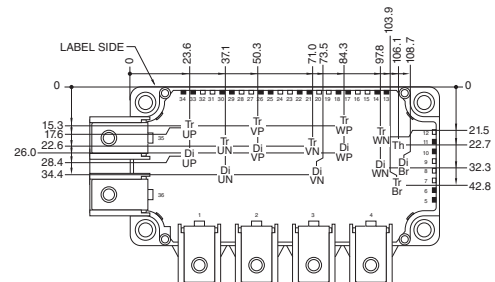
**Inverter Part IGBT/FWDI**

| Characteristics                      | Symbol                      | Test Conditions   | Min. | Typ. | Max. | Units         |
|--------------------------------------|-----------------------------|---|------|------|------|---------------|
| Collector-Emitter Cutoff Current     | $I_{CES}$                   | $V_{CE} = V_{CES}, V_{GE} = 0V$                                   | —    | —    | 1.0  | mA            |
| Gate-Emitter Leakage Current         | $I_{GES}$                   | $V_{GE} = V_{GES}, V_{CE} = 0V$                                   | —    | —    | 0.5  | $\mu\text{A}$ |
| Gate-Emitter Threshold Voltage       | $V_{GE(th)}$                | $I_C = 15\text{mA}, V_{CE} = 10V$                                 | 5.4  | 6.0  | 6.6  | Volts         |
| Collector-Emitter Saturation Voltage | $V_{CE(sat)}$<br>(Terminal) | $I_C = 150\text{A}, V_{GE} = 15V, T_j = 25^\circ\text{C}^{*5}$    | —    | 1.80 | 2.25 | Volts         |
|                                      |                             | $I_C = 150\text{A}, V_{GE} = 15V, T_j = 125^\circ\text{C}^{*5}$   | —    | 2.00 | —    | Volts         |
|                                      |                             | $I_C = 150\text{A}, V_{GE} = 15V, T_j = 150^\circ\text{C}^{*5}$   | —    | 2.05 | —    | Volts         |
| Collector-Emitter Saturation Voltage | $V_{CE(sat)}$<br>(Chip)     | $I_C = 150\text{A}, V_{GE} = 15V, T_j = 25^\circ\text{C}^{*5}$    | —    | 1.70 | 2.15 | Volts         |
|                                      |                             | $I_C = 150\text{A}, V_{GE} = 15V, T_j = 125^\circ\text{C}^{*5}$   | —    | 1.90 | —    | Volts         |
|                                      |                             | $I_C = 150\text{A}, V_{GE} = 15V, T_j = 150^\circ\text{C}^{*5}$   | —    | 1.95 | —    | Volts         |
| Input Capacitance                    | $C_{ies}$                   |   | —    | —    | 15   | nF            |
| Output Capacitance                   | $C_{oes}$                   | $V_{CE} = 10V, V_{GE} = 0V$                                       | —    | —    | 3.0  | nF            |
| Reverse Transfer Capacitance         | $C_{res}$                   |   | —    | —    | 0.25 | nF            |
| Gate Charge                          | $Q_G$                       | $V_{CC} = 600V, I_C = 150A, V_{GE} = 15V$                         | —    | 350  | —    | nC            |
| Turn-on Delay Time                   | $t_{d(on)}$                 |   | —    | —    | 800  | ns            |
| Rise Time                            | $t_r$                       | $V_{CC} = 600V, I_C = 150A, V_{GE} = \pm 15V,$                    | —    | —    | 200  | ns            |
| Turn-off Delay Time                  | $t_{d(off)}$                | $R_G = 0\Omega, \text{Inductive Load}$                            | —    | —    | 600  | ns            |
| Fall Time                            | $t_f$                       |   | —    | —    | 300  | ns            |
| Emitter-Collector Voltage            | $V_{EC}^{*1}$<br>(Terminal) | $I_E = 150A, V_{GE} = 0V, T_j = 25^\circ\text{C}^{*5}$            | —    | 1.80 | 2.25 | Volts         |
|                                      |                             | $I_E = 150A, V_{GE} = 0V, T_j = 125^\circ\text{C}^{*5}$           | —    | 1.80 | —    | Volts         |
|                                      |                             | $I_E = 150A, V_{GE} = 0V, T_j = 150^\circ\text{C}^{*5}$           | —    | 1.80 | —    | Volts         |
| Emitter-Collector Voltage            | $V_{EC}^{*1}$<br>(Chip)     | $I_E = 150A, V_{GE} = 0V, T_j = 25^\circ\text{C}^{*5}$            | —    | 1.70 | 2.15 | Volts         |
|                                      |                             | $I_E = 150A, V_{GE} = 0V, T_j = 125^\circ\text{C}^{*5}$           | —    | 1.70 | —    | Volts         |
|                                      |                             | $I_E = 150A, V_{GE} = 0V, T_j = 150^\circ\text{C}^{*5}$           | —    | 1.70 | —    | Volts         |
| Reverse Recovery Time                | $t_{rr}^{*1}$               | $V_{CC} = 600V, I_E = 150A, V_{GE} = \pm 15V$                     | —    | —    | 300  | ns            |
| Reverse Recovery Charge              | $Q_{rr}^{*1}$               | $R_G = 0\Omega, \text{Inductive Load}$                            | —    | 8.0  | —    | $\mu\text{C}$ |
| Turn-on Switching Energy per Pulse   | $E_{on}$                    | $V_{CC} = 600V, I_C = I_E = 150A,$                                | —    | 24.2 | —    | mJ            |
| Turn-off Switching Energy per Pulse  | $E_{off}$                   | $V_{GE} = \pm 15V, R_G = 0\Omega,$                                | —    | 16   | —    | mJ            |
| Reverse Recovery Energy per Pulse    | $E_{rr}^{*1}$               | $T_j = 150^\circ\text{C}, \text{Inductive Load}$                  | —    | 12.2 | —    | mJ            |
| Internal Lead Resistance             | $R_{CC}^{*4} + EE^{*4}$     | Main Terminals-Chip,<br>Per Switch, $T_C = 25^\circ\text{C}^{*4}$ | —    | —    | 1.8  | m $\Omega$    |
| Internal Gate Resistance             | $r_g$                       | Per Switch  | —    | 13   | —    | $\Omega$      |

\*1 Represent ratings and characteristics of the anti-parallel, emitter-to-collector free wheeling diode (FWDI).

\*4 Case temperature ( $T_C$ ) and heatsink temperature ( $T_S$ ) is measured on the surface (mounting side) of the baseplate and the heatsink side just under the chips. Refer to the figure to the right for chip location. The heatsink thermal resistance should be measured just under the chips.

\*5 Pulse width and repetition rate should be such as to cause negligible temperature rise.



Each mark points to the center position of each chip.

Tr\*P / Tr\*N / Tr\*Br (\* = U/V/W): IGBT Di\*P / Di\*N (\* = U/V/W): FWDI  
 DIBr: Clamp Th: NTC Thermistor

**CM150RX-24S**  
**Six IGBT + Brake NX-Series Module**  
 150 Amperes/1200 Volts

**Electrical Characteristics,  $T_j = 25^\circ\text{C}$  unless otherwise specified**

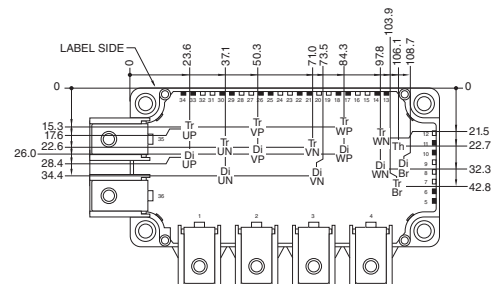
**Brake Part IGBT/ClampDi**

| Characteristics                      | Symbol                      | Test Conditions   | Min. | Typ. | Max. | Units         |
|--------------------------------------|-----------------------------|---|------|------|------|---------------|
| Collector-Emitter Cutoff Current     | $I_{CES}$                   | $V_{CE} = V_{CES}, V_{GE} = 0V$                         | —    | —    | 1.0  | mA            |
| Gate-Emitter Leakage Current         | $I_{GES}$                   | $V_{GE} = V_{GES}, V_{CE} = 0V$                         | —    | —    | 0.5  | $\mu\text{A}$ |
| Gate-Emitter Threshold Voltage       | $V_{GE(th)}$                | $I_C = 7.5\text{mA}, V_{CE} = 10V$                      | 5.4  | 6.0  | 6.6  | Volts         |
| Collector-Emitter Saturation Voltage | $V_{CE(sat)}$<br>(Terminal) | $I_C = 75A, V_{GE} = 15V, T_j = 25^\circ\text{C}^{*5}$  | —    | 1.80 | 2.25 | Volts         |
|                                      |                             | $I_C = 75A, V_{GE} = 15V, T_j = 125^\circ\text{C}^{*5}$ | —    | 2.00 | —    | Volts         |
|                                      |                             | $I_C = 75A, V_{GE} = 15V, T_j = 150^\circ\text{C}^{*5}$ | —    | 2.05 | —    | Volts         |
| Collector-Emitter Saturation Voltage | $V_{CE(sat)}$<br>(Chip)     | $I_C = 75A, V_{GE} = 15V, T_j = 25^\circ\text{C}^{*5}$  | —    | 1.70 | 2.15 | Volts         |
|                                      |                             | $I_C = 75A, V_{GE} = 15V, T_j = 125^\circ\text{C}^{*5}$ | —    | 1.90 | —    | Volts         |
|                                      |                             | $I_C = 75A, V_{GE} = 15V, T_j = 150^\circ\text{C}^{*5}$ | —    | 1.95 | —    | Volts         |
| Input Capacitance                    | $C_{ies}$                   |   | —    | —    | 7.5  | nF            |
| Output Capacitance                   | $C_{oes}$                   | $V_{CE} = 10V, V_{GE} = 0V$                             | —    | —    | 1.5  | nF            |
| Reverse Transfer Capacitance         | $C_{res}$                   |   | —    | —    | 0.13 | nF            |
| Gate Charge                          | $Q_G$                       | $V_{CC} = 600V, I_C = 75A, V_{GE} = 15V$                | —    | 175  | —    | nC            |
| Turn-on Delay Time                   | $t_{d(on)}$                 |   | —    | —    | 300  | ns            |
| Rise Time                            | $t_r$                       | $V_{CC} = 600V, I_C = 75A, V_{GE} = \pm 15V,$           | —    | —    | 200  | ns            |
| Turn-off Delay Time                  | $t_{d(off)}$                | $R_G = 8.2\Omega, \text{Inductive Load}$                | —    | —    | 600  | ns            |
| Fall Time                            | $t_f$                       |   | —    | —    | 300  | ns            |
| Repetitive Peak Reverse Current      | $I_{RRM}$                   | $V_R = V_{RRM}, V_{GE} = 0V$                            | —    | —    | 1.0  | mA            |
| Forward Voltage                      | $V_F$<br>(Terminal)         | $I_E = 75A, V_{GE} = 0V, T_j = 25^\circ\text{C}^{*5}$   | —    | 1.80 | 2.25 | Volts         |
|                                      |                             | $I_E = 75A, V_{GE} = 0V, T_j = 125^\circ\text{C}^{*5}$  | —    | 1.80 | —    | Volts         |
|                                      |                             | $I_E = 75A, V_{GE} = 0V, T_j = 150^\circ\text{C}^{*5}$  | —    | 1.80 | —    | Volts         |
| Forward Voltage                      | $V_F$<br>(Chip)             | $I_E = 75A, V_{GE} = 0V, T_j = 25^\circ\text{C}^{*5}$   | —    | 1.70 | 2.15 | Volts         |
|                                      |                             | $I_E = 75A, V_{GE} = 0V, T_j = 125^\circ\text{C}^{*5}$  | —    | 1.70 | —    | Volts         |
|                                      |                             | $I_E = 75A, V_{GE} = 0V, T_j = 150^\circ\text{C}^{*5}$  | —    | 1.70 | —    | Volts         |
| Reverse Recovery Time                | $t_{rr}^{*1}$               | $V_{CC} = 600V, I_E = 75A, V_{GE} = \pm 15V$            | —    | —    | 300  | ns            |
| Reverse Recovery Charge              | $Q_{rr}^{*1}$               | $R_G = 8.2\Omega, \text{Inductive Load}$                | —    | 4.0  | —    | $\mu\text{C}$ |
| Turn-on Switching Energy per Pulse   | $E_{on}$                    | $V_{CC} = 600V, I_C = I_E = 75A,$                       | —    | 7.3  | —    | mJ            |
| Turn-off Switching Energy per Pulse  | $E_{off}$                   | $V_{GE} = \pm 15V, R_G = 8.2\Omega,$                    | —    | 8.0  | —    | mJ            |
| Reverse Recovery Energy per Pulse    | $E_{rr}^{*1}$               | $T_j = 150^\circ\text{C}, \text{Inductive Load}$        | —    | 6.9  | —    | mJ            |
| Internal Gate Resistance             | $r_g$                       |   | —    | 0    | —    | $\Omega$      |

\*1 Represent ratings and characteristics of the anti-parallel, emitter-to-collector free wheeling diode (FWDi).

\*4 Case temperature ( $T_C$ ) and heatsink temperature ( $T_S$ ) is measured on the surface (mounting side) of the baseplate and the heatsink side just under the chips. Refer to the figure to the right for chip location. The heatsink thermal resistance should be measured just under the chips.

\*5 Pulse width and repetition rate should be such as to cause negligible temperature rise.



Each mark points to the center position of each chip.

Tr\*P / Tr\*N / TrBr (\* = U/V/W): IGBT      Di\*P / Di\*N (\* = U/V/W): FWDi  
 DIBr: Clamp      Th: NTC Thermistor

**CM150RX-24S**  
**Six IGBT + Brake NX-Series Module**  
 150 Amperes/1200 Volts

**Electrical Characteristics,  $T_j = 25^\circ\text{C}$  unless otherwise specified (continued)**

**NTC Thermistor Part**

| Characteristics         | Symbol        | Test Conditions                                     | Min. | Typ. | Max. | Units      |
|-------------------------|---------------|---|------|------|------|------------|
| Zero Power Resistance   | $R_{25}$      | $T_C = 25^\circ\text{C}^4$                          | 4.85 | 5.00 | 5.15 | k $\Omega$ |
| Deviation of Resistance | $\Delta R/R$  | $T_C = 100^\circ\text{C}^4$ , $R_{100} = 493\Omega$ | -7.3 | —    | +7.8 | %          |
| B Constant              | $B_{(25/50)}$ | Approximate by Equation <sup>6</sup>                | —    | 3375 | —    | K          |
| Power Dissipation       | $P_{25}$      | $T_C = 25^\circ\text{C}^4$                          | —    | —    | 10   | mW         |

**Thermal Resistance Characteristics**

|   |                |   |   |    |      |      |
|---|----------------|---|---|----|------|------|
| Thermal Resistance, Junction to Case <sup>4</sup>         | $R_{th(j-c)Q}$ | Per Inverter IGBT                                 | — | —  | 0.13 | K/W  |
| Thermal Resistance, Junction to Case <sup>4</sup>         | $R_{th(j-c)D}$ | Per Inverter FWDi                                 | — | —  | 0.23 | K/W  |
| Thermal Resistance, Junction to Case <sup>4</sup>         | $R_{th(j-c)Q}$ | Per Brake IGBT                                    | — | —  | 0.25 | K/W  |
| Thermal Resistance, Junction to Case <sup>4</sup>         | $R_{th(j-c)D}$ | Per Brake ClampDi                                 | — | —  | 0.40 | K/W  |
| Contact Thermal Resistance, Case to Heatsink <sup>4</sup> | $R_{th(c-f)}$  | Thermal Grease Applied, Per 1 Module <sup>7</sup> | — | 15 | —    | K/kW |

**Mechanical Characteristics**

|                       |       |                                 |         |     |           |               |
|-----------------------|-------|---------------------------------|---------|-----|-----------|---------------|
| Mounting Torque       | $M_t$ | Main Terminal, M5 Screw         | 22      | 27  | 31        | in-lb         |
| Mounting Torque       | $M_s$ | Mounting to Heatsink, M5 Screw  | 22      | 27  | 31        | in-lb         |
| Creepage Distance     | $d_s$ | Terminal to Terminal            | 10.25   | —   | —         | mm            |
|                       |       | Terminal to Baseplate           | 12.32   | —   | —         | mm            |
| Clearance             | $d_a$ | Terminal to Terminal            | 10.28   | —   | —         | mm            |
|                       |       | Terminal to Baseplate           | 10.85   | —   | —         | mm            |
| Weight                | $m$   |                                 |         | 370 |           | g             |
| Flatness of Baseplate | $e_c$ | On Centerline X, Y <sup>8</sup> | $\pm 0$ | —   | $\pm 100$ | $\mu\text{m}$ |

**Recommended Operating Conditions,  $T_a = 25^\circ\text{C}$**

|                            |              |   |      |      |      |          |
|----------------------------|--------------|---|------|------|------|----------|
| DC Supply Voltage          | $V_{CC}$     | Applied Across P-N Terminals                                | —    | 600  | 850  | Volts    |
| Gate-Emitter Drive Voltage | $V_{GE(on)}$ | Applied Across<br>G*P-Es*P/G*N-Es*N (* = U, V, W) Terminals | 13.5 | 15.0 | 16.5 | Volts    |
| External Gate Resistance   | $R_G$        | Per Switch Inverter IGBT                                    | 0    | —    | 30   | $\Omega$ |
|                            |              | Per Switch Brake IGBT                                       | 8.2  | —    | 82   | $\Omega$ |

<sup>4</sup> Case temperature ( $T_C$ ) and heatsink temperature ( $T_s$ ) is measured on the surface (mounting side) of the baseplate and the heatsink side just under the chips. Refer to the figure to the right for chip location. The heatsink thermal resistance should be measured just under the chips.

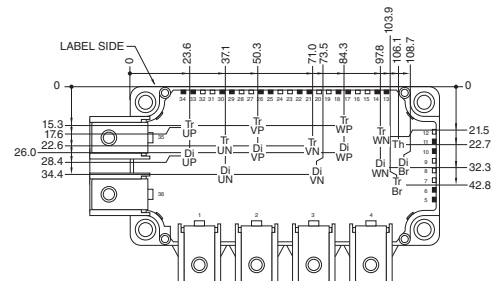
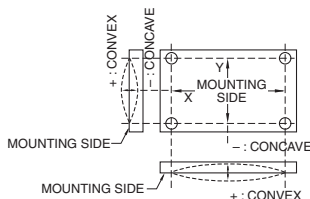
$$^6 B_{(25/50)} = \ln\left(\frac{R_{25}}{R_{50}}\right) / \left(\frac{1}{T_{25}} - \frac{1}{T_{50}}\right)$$

$R_{25}$ ; Resistance at Absolute Temperature  $T_{25}$  [K];  $T_{25} = 25 [^\circ\text{C}] + 273.15 = 298.15$  [K]

$R_{50}$ ; Resistance at Absolute Temperature  $T_{50}$  [K];  $T_{50} = 50 [^\circ\text{C}] + 273.15 = 323.15$  [K]

<sup>7</sup> Typical value is measured by using thermally conductive grease of  $\lambda = 0.9$  [W/(m • K)].

<sup>8</sup> Baseplate (mounting side) flatness measurement points (X, Y) are shown in the figure below.

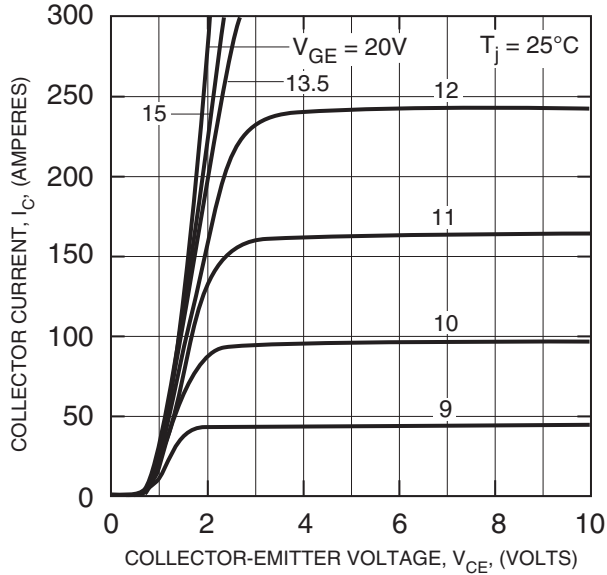


Each mark points to the center position of each chip.

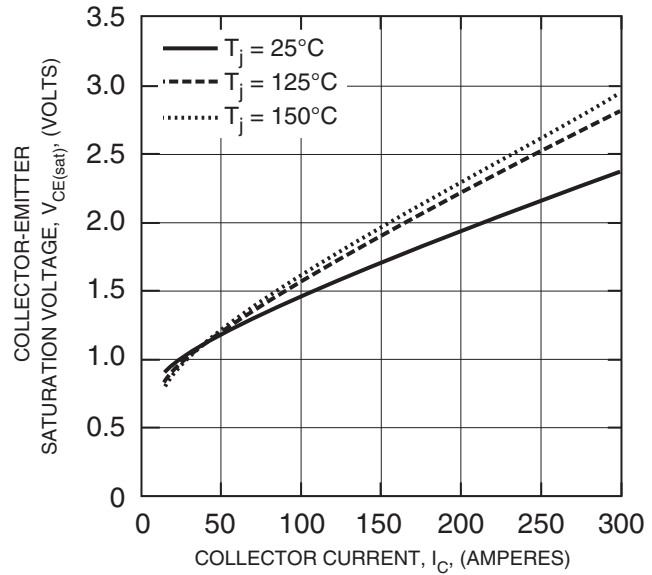
Tr\*P / Tr\*N / TrBr (\* = U/V/W): IGBT      Di\*P / Di\*N (\* = U/V/W): FWDi  
 DiBr: Clamp      Th: NTC Thermistor

**CM150RX-24S**  
**Six IGBT + Brake NX-Series Module**  
 150 Amperes/1200 Volts

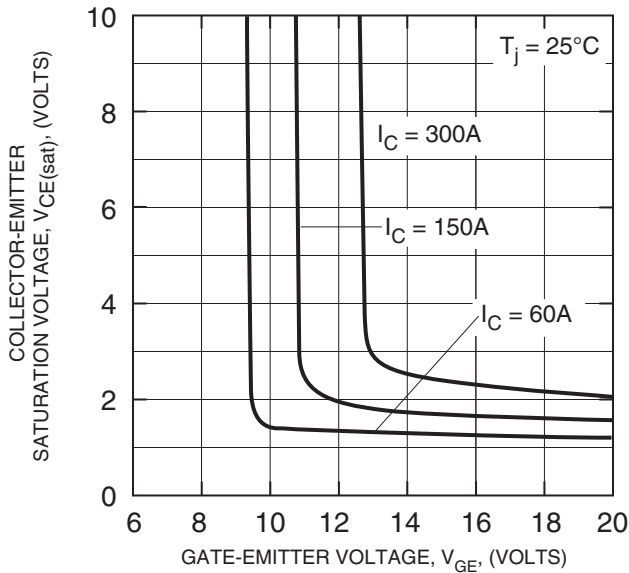
**OUTPUT CHARACTERISTICS  
 (INVERTER PART - TYPICAL)**



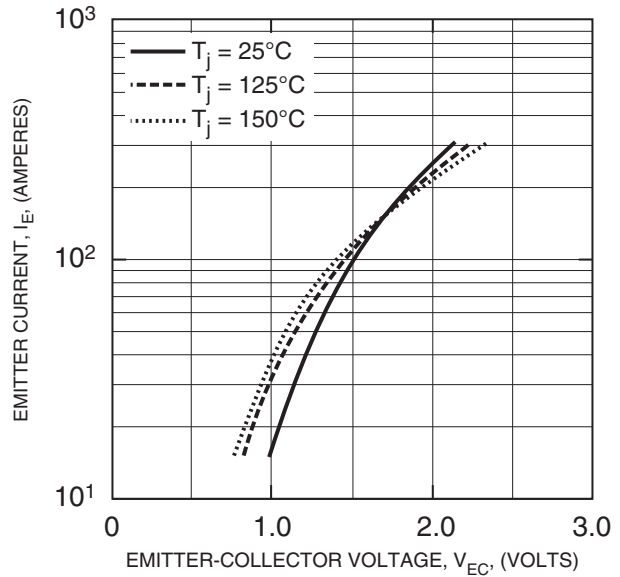
**COLLECTOR-EMITTER  
 SATURATION VOLTAGE CHARACTERISTICS  
 (INVERTER PART - TYPICAL)**



**COLLECTOR-EMITTER  
 SATURATION VOLTAGE CHARACTERISTICS  
 (INVERTER PART - TYPICAL)**

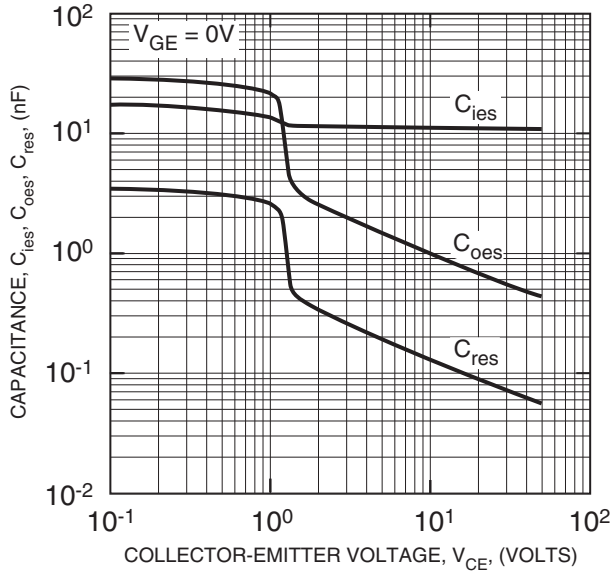


**FREE-WHEEL DIODE  
 FORWARD CHARACTERISTICS  
 (INVERTER PART - TYPICAL)**

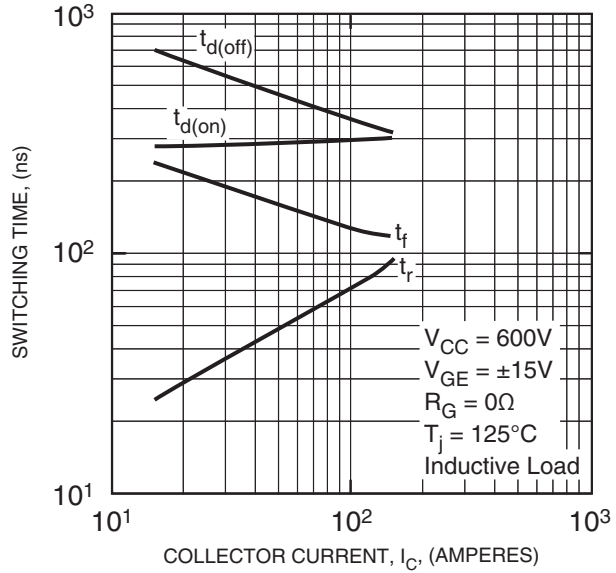


**CM150RX-24S**  
**Six IGBT + Brake NX-Series Module**  
 150 Amperes/1200 Volts

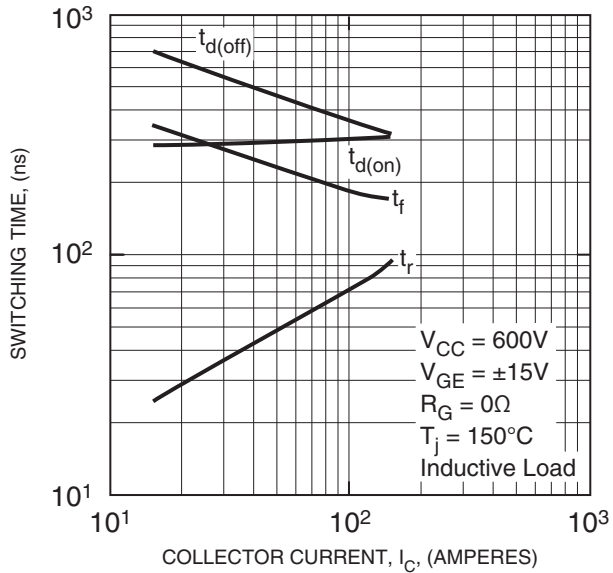
**CAPACITANCE VS.  $V_{CE}$**   
 (INVERTER PART - TYPICAL)



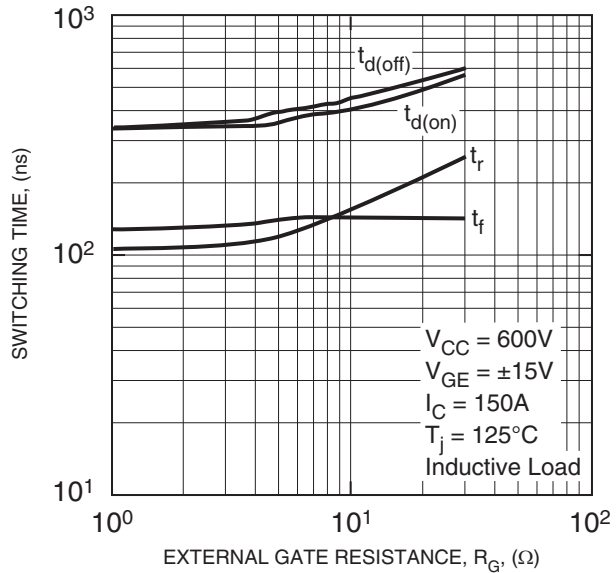
**HALF-BRIDGE SWITCHING CHARACTERISTICS**  
 (INVERTER PART - TYPICAL)



**HALF-BRIDGE SWITCHING CHARACTERISTICS**  
 (INVERTER PART - TYPICAL)

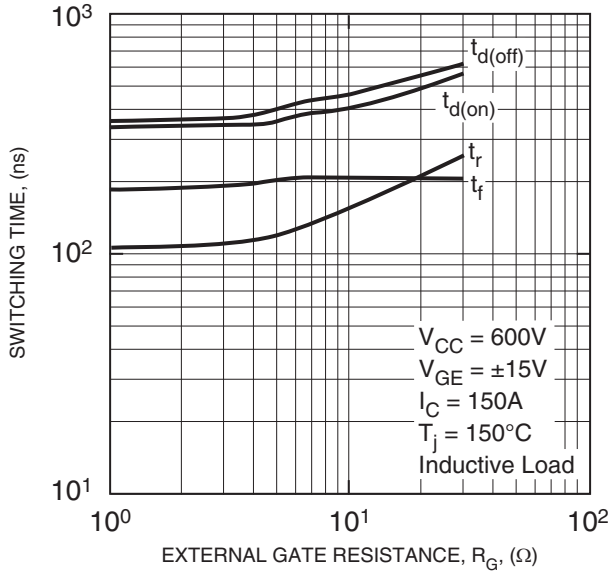


**SWITCHING TIME VS. GATE RESISTANCE**  
 (INVERTER PART - TYPICAL)

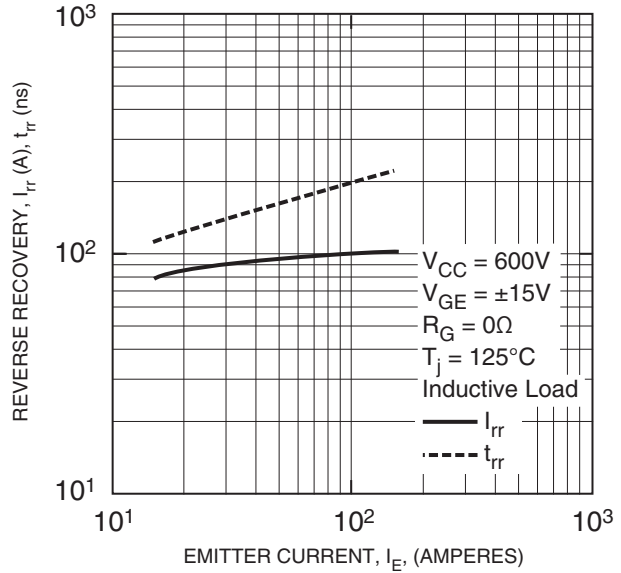


**CM150RX-24S**  
**Six IGBT + Brake NX-Series Module**  
 150 Amperes/1200 Volts

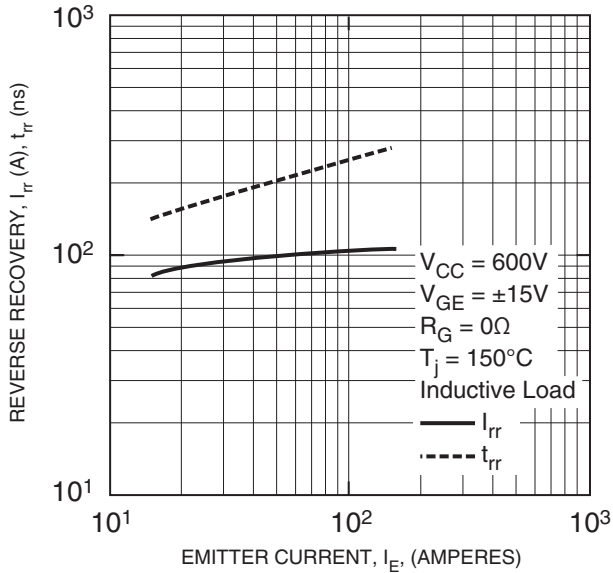
**SWITCHING TIME VS. GATE RESISTANCE (INVERTER PART - TYPICAL)**



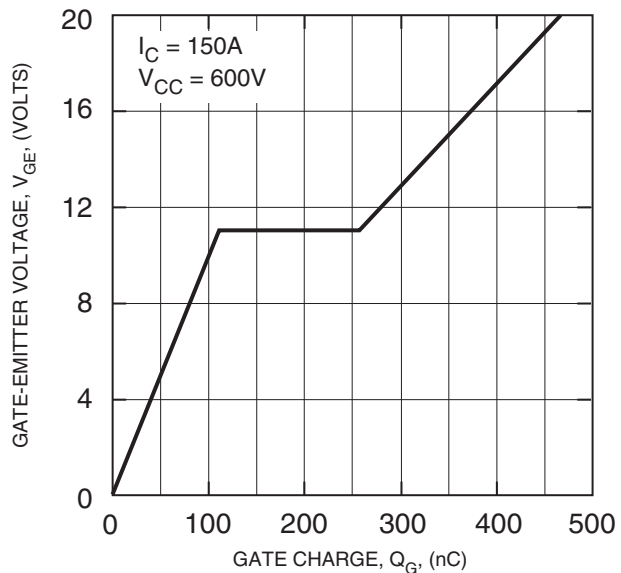
**REVERSE RECOVERY CHARACTERISTICS (INVERTER PART - TYPICAL)**



**REVERSE RECOVERY CHARACTERISTICS (INVERTER PART - TYPICAL)**



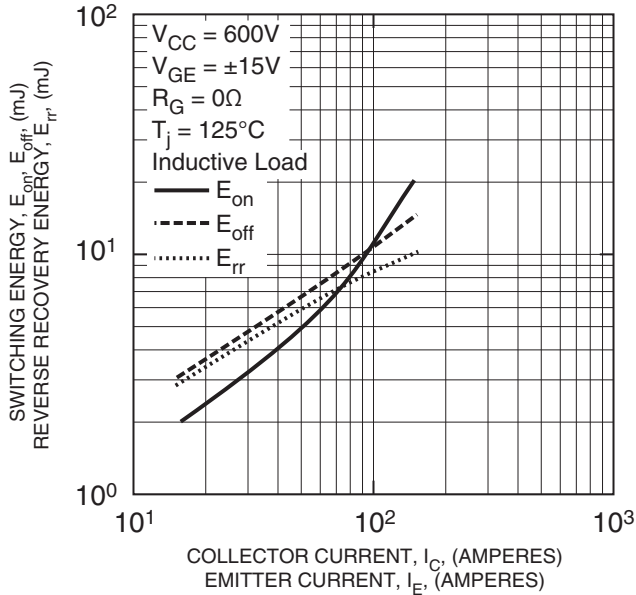
**GATE CHARGE VS. V\_GE (INVERTER PART)**



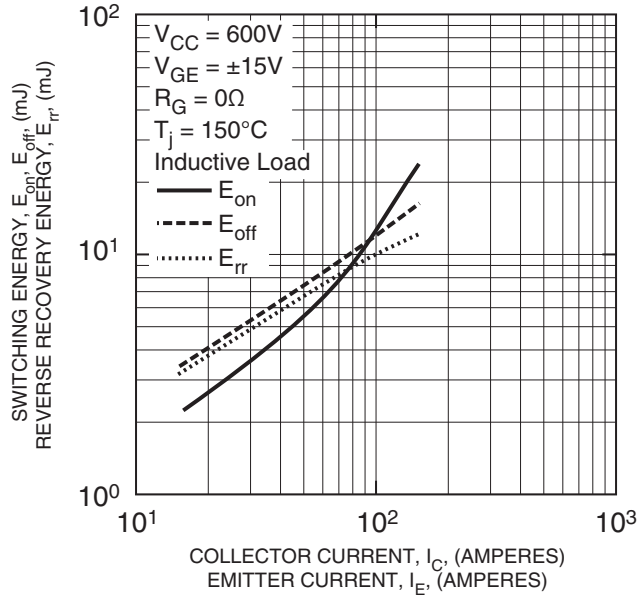


**CM150RX-24S**  
**Six IGBT + Brake NX-Series Module**  
 150 Amperes/1200 Volts

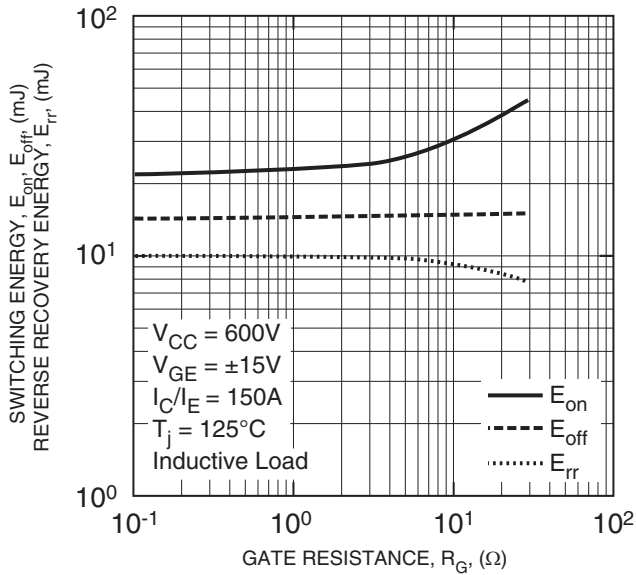
**HALF-BRIDGE SWITCHING CHARACTERISTICS (INVERTER PART - TYPICAL)**



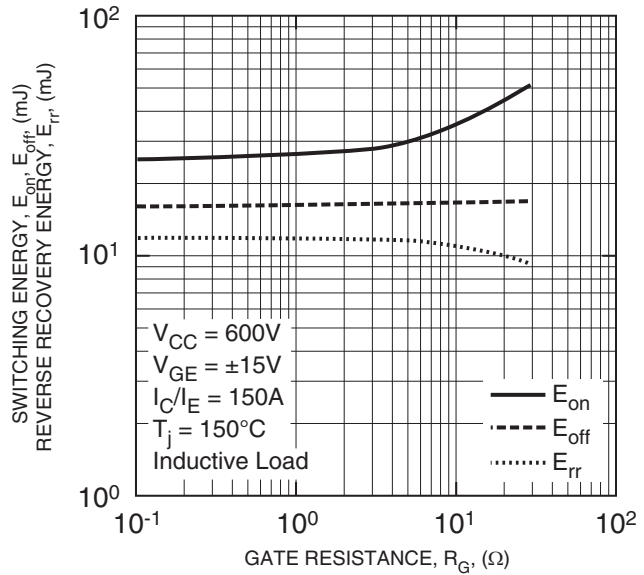
**HALF-BRIDGE SWITCHING CHARACTERISTICS (INVERTER PART - TYPICAL)**



**HALF-BRIDGE SWITCHING CHARACTERISTICS (INVERTER PART - TYPICAL)**

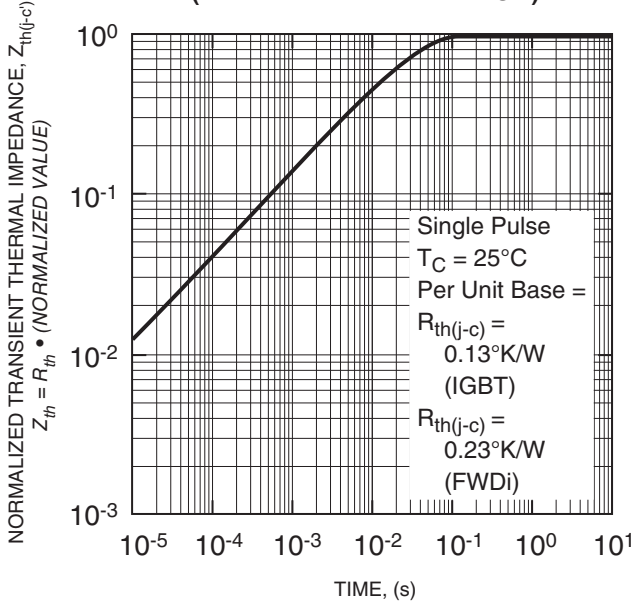


**HALF-BRIDGE SWITCHING CHARACTERISTICS (INVERTER PART - TYPICAL)**

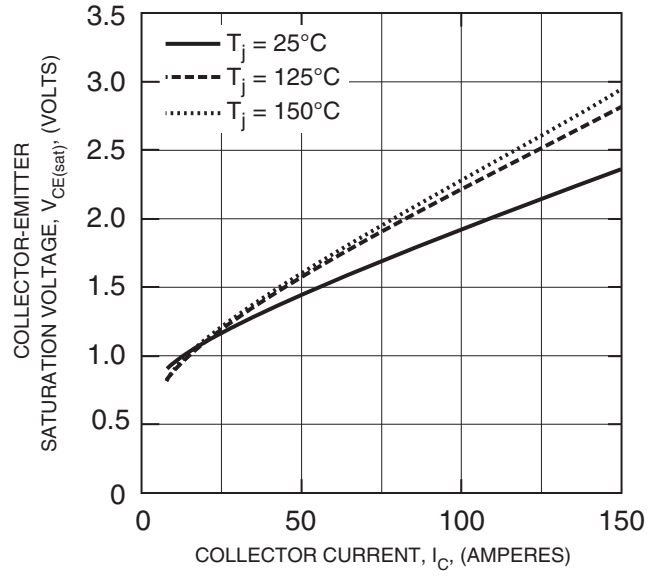


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**Six IGBT + Brake NX-Series Module**  
 150 Amperes/1200 Volts

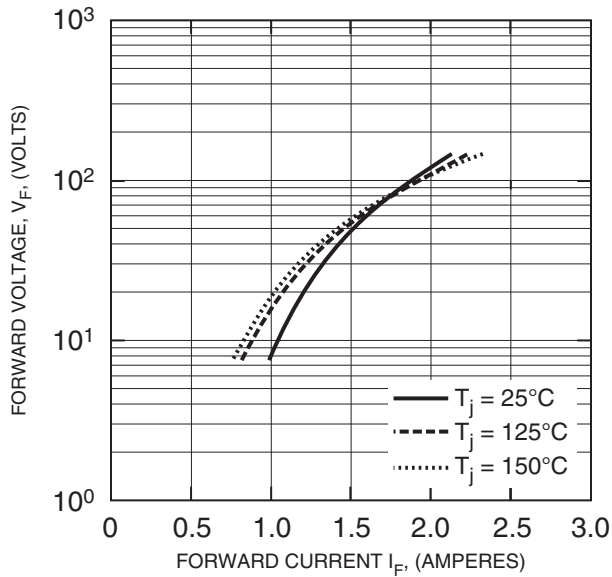
**TRANSIENT THERMAL IMPEDANCE CHARACTERISTICS (INVERTER PART - MAXIMUM)**



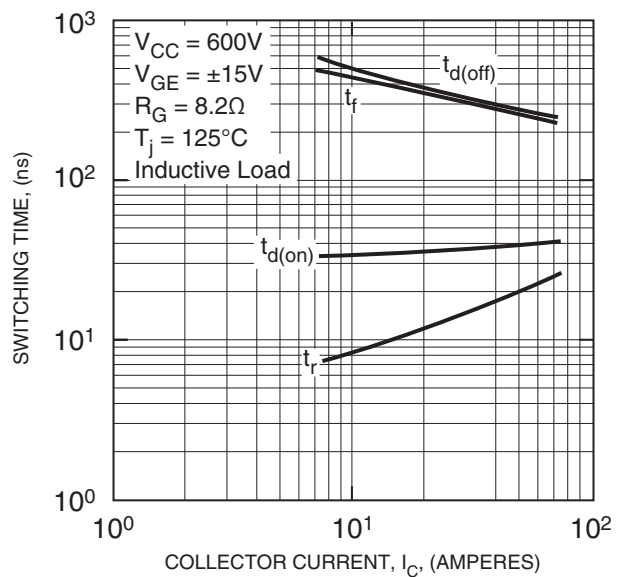
**COLLECTOR-EMITTER SATURATION VOLTAGE CHARACTERISTICS (BRAKE PART - TYPICAL)**



**FREE-WHEEL DIODE FORWARD CHARACTERISTICS (BRAKE PART - TYPICAL)**

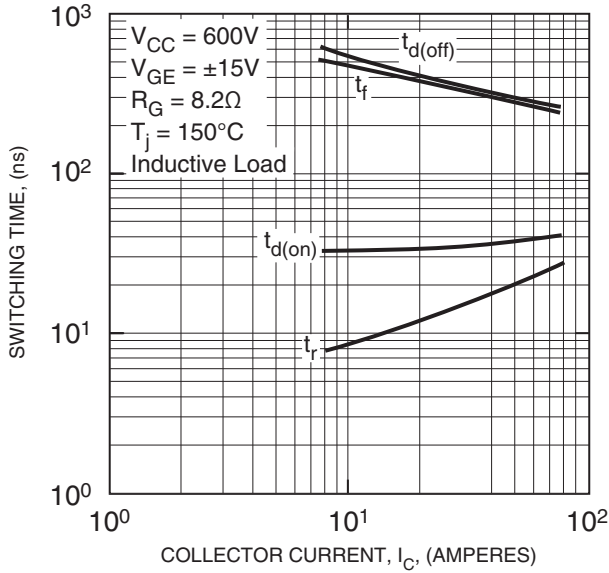


**HALF-BRIDGE SWITCHING CHARACTERISTICS (BRAKE PART - TYPICAL)**

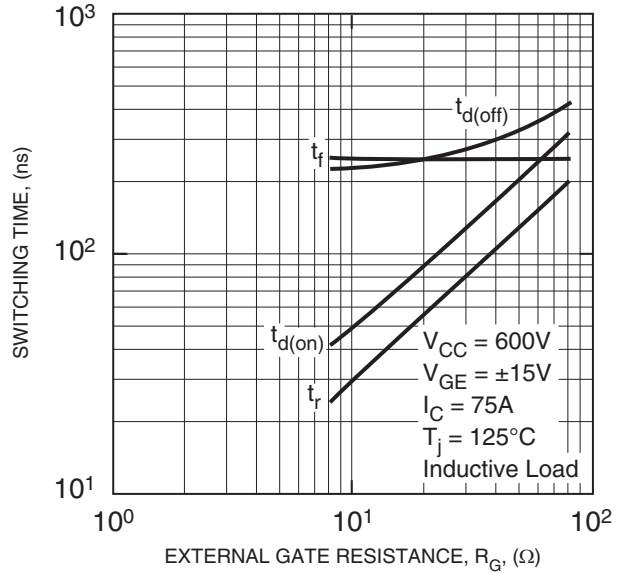


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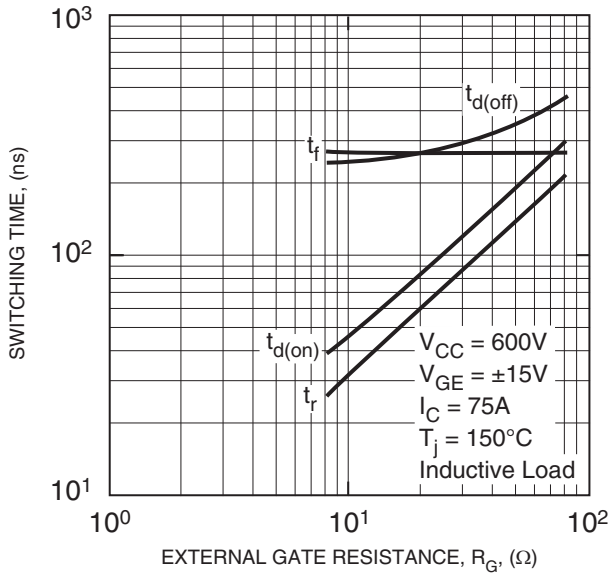
**HALF-BRIDGE SWITCHING CHARACTERISTICS (BRAKE PART - TYPICAL)**



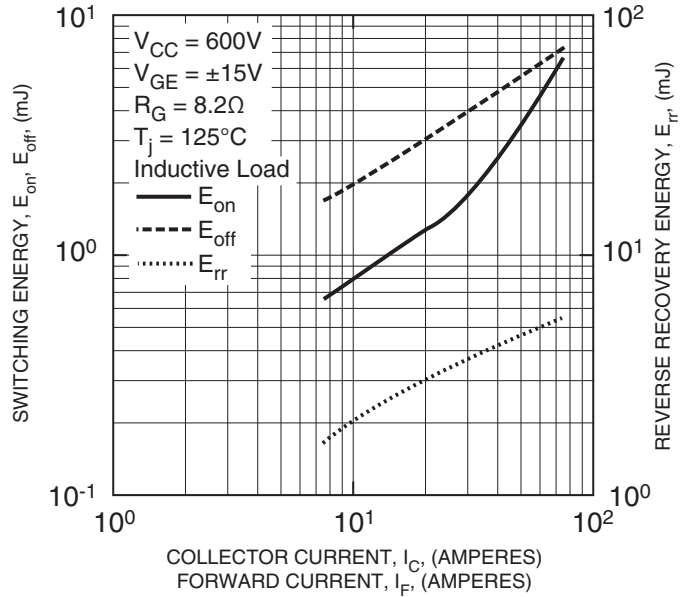
**SWITCHING TIME VS. GATE RESISTANCE (BRAKE - TYPICAL)**



**SWITCHING TIME VS. GATE RESISTANCE (BRAKE - TYPICAL)**

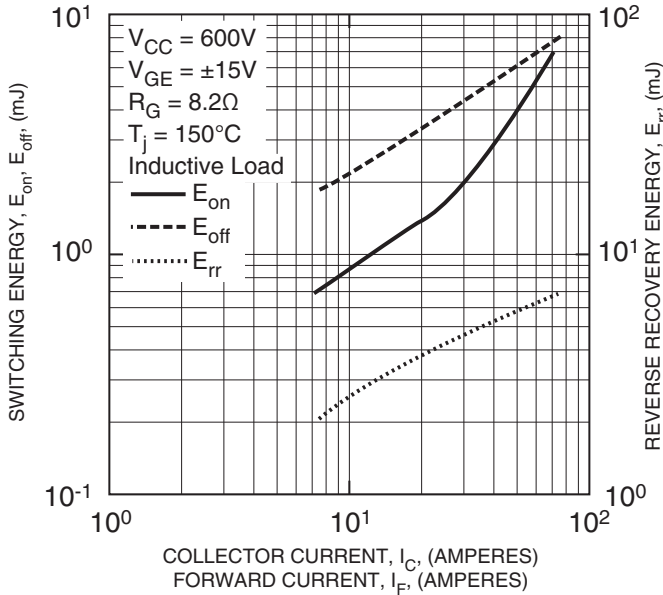


**HALF-BRIDGE SWITCHING CHARACTERISTICS (BRAKE PART - TYPICAL)**

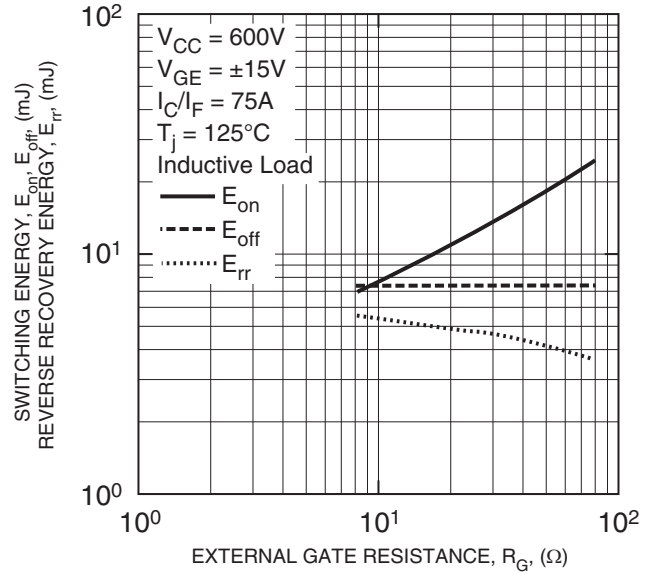


**CM150RX-24S**  
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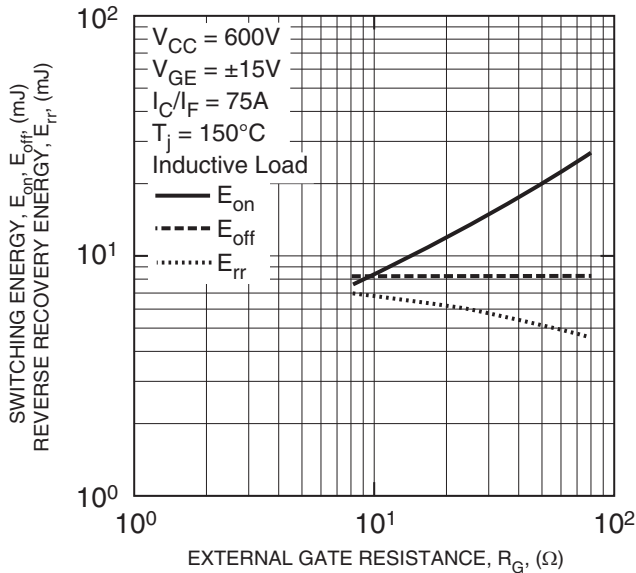
**HALF-BRIDGE SWITCHING CHARACTERISTICS (BRAKE PART - TYPICAL)**



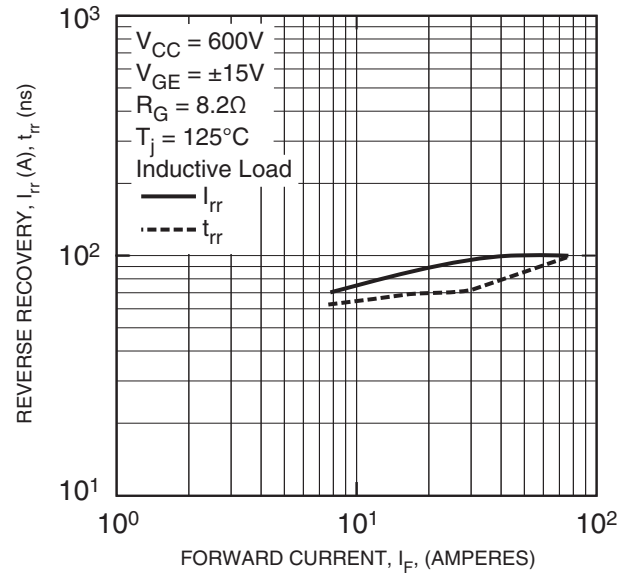
**HALF-BRIDGE SWITCHING CHARACTERISTICS (BRAKE PART - TYPICAL)**



**HALF-BRIDGE SWITCHING CHARACTERISTICS (BRAKE PART - TYPICAL)**



**REVERSE RECOVERY CHARACTERISTICS (BRAKE PART - TYPICAL)**



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 150 Amperes/1200 Volts

